ASOCIATION CONNECTING LECTRONICS INDUSTRIES® INCLUSTRIES®	C. Bannockł	ourn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declar he declaratio	ation of the n encompas	substance ses all low	s within the er level ma	e manufacture terials for wh	er listed it hich the m	em. Note: anufactur	if the item is an a er has engineering	ssembly with lower responsibility.
	21.1 IPC Web Site for Information on IPC-1752 Standard Form Dist				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					eous Materia	als and Mfg Information			
Supplier Information														
Company name*	Company unique ID				Unique ID Authority					Response Date*				
nsemi											2025-06-02			
ontact Name Title - Contact						Phone - Contact*					Email - Contact*			
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title			Fitle - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Envir			Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item	n Number	umber Mfr Item Name			Effective Da	te Versio	n	Manufacturing Site		V	Weight*	UOM	Unit Type
	NCP193	NCP1937A2DR2G COMBO PF CNTRL		C & QUAZI FLYBACK		2025-06-02			PH1		1	66.78	mg	Each
Manufacturing Proccess Informat	ion													
Terminal Plating / Grid Array Ma	ay Material Terminal Base Alloy			J-STD-020 MSI	Rating	Peak Process Body Temperature Max T			`ime at Peak '	eak Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30		secon	ds 3			
Comments														
evel 1 - maximum time at peak temperatu	re during so	ldering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	toHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.32	mg	Supplier	Silicon (Si)	7440-21-3		1.32	mg
Die Attach 0.48	0.48	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.096	mg
			Supplier	Silver (Ag)	7440-22-4		0.384	mg
Lead Frame 36.00	36.06	mg	Supplier	Silver (Ag)	7440-22-4		0.0288	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0433	mg
			Supplier	Iron (Fe)	7439-89-6		0.8474	mg
			Supplier	Copper (Cu)	7440-50-8		35.1297	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0108	mg
Mold Compound-Black	125.7	mg		Epoxy Phenol Resin	proprietary data		13.1985	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		112.5015	mg
Plating	2.75	mg	Supplier	Tin (Sn)	7440-31-5		2.75	mg
Wire Bond - Au	0.47	mg	Supplier	Gold (Au)	7440-57-5		0.47	mg